

R&D Projects in IMA

Technology Topics

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ITEA4



ECSEL Joint Undertaking

Electronic Components and Systems for European Leadership



ArchitectECA2030

- Robust mission-validated traceable design of electronic components and systems (ECS)
- Quantification of an accepted residual risk of ECS for ECA vehicles to enable type approval, and
- Increased end-user acceptance due to more reliable and robust ECS.

IMA challenges w.r.t. standards

- ⌚ How to collect requirements on the Test Code (TC) & Code Review (CR)
- ⌚ How to set up methodology and criteria for TC development and CR
- ⌚ How to apply CR methodology
- ⌚ How to perform validation test
- ⌚ How to evaluate test results

ARCHITECT ECA 2030



Trustable ECS Value Chain for L3, L4, L5 vehicle

ISO/PAS 21448
ISO 26262



- New materials for high volume piezoelectric acoustic transducers
- Size reduction > higher sensitivity > consumption reduction > demonstrating the dual frequency PMUTs > more efficient piezoelectric thin film materials > improving ASIC immunity against ultrasound attacks in voice control systems

IMA owner of the UC <Infrastructure monitoring and maintenance optimization>

- © Partners: UTIA, BUT, SINTEF, IFAT, IFD, CODA
- © Localization and identification of issues on electric distribution network, specifically within substation.
- © Reduction of an unexpected breakdown of critical components and avoid unexpected maintenance
- © AI experience utilization



A-IQ Ready



IMA is partner of Safe co-existence of automated and manual transport at industrial sites - Industrial park demonstrator

IMA challenges

- ⌚ Improvement of human safety using a radar-based platform (RBP) implementation on industrial machines (Reachstacker Kalmar)
- ⌚ MA seeks to build a base for a new product that consists of the system for monitoring and detection of the objects and obstacles, software services processing and interpreting the sensor data. AI model will be implemented.
- ⌚ Investigation of processes at container terminal in Prague
- ⌚ RBP system demo at Kouvola Rail and Road Terminal (Finland)



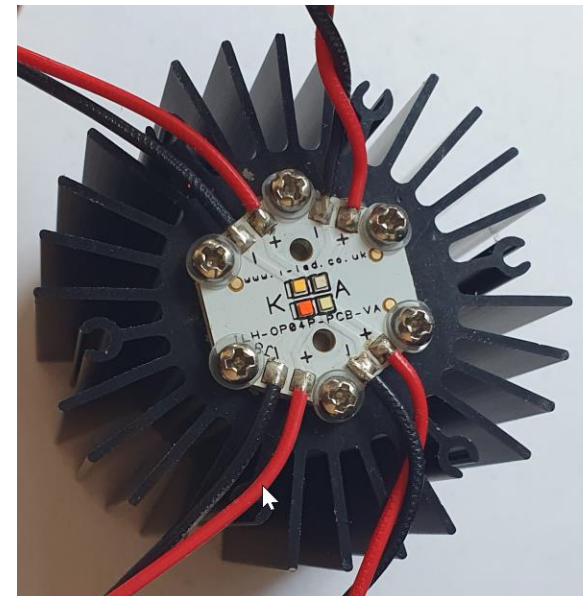
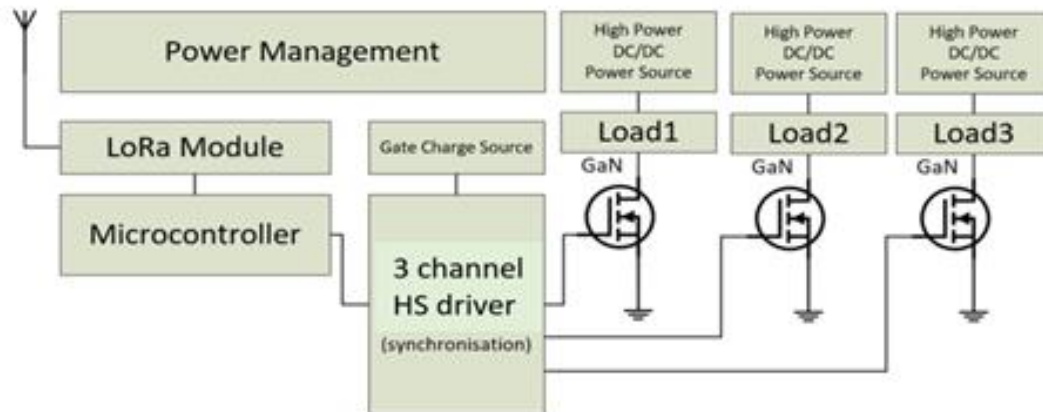
Member of



- Gallium nitride (GaN) is a wide-bandgap material that could take electronic performance to the next level
- New generation of vertical power GaN-based devices on MOSFET architecture
- New concept high-frequency packages that can achieve the requested 99% power conversion efficiency.

IMA challenge

- ☾ GaN-based power actuator for remote control in industry digitalization and IoT network



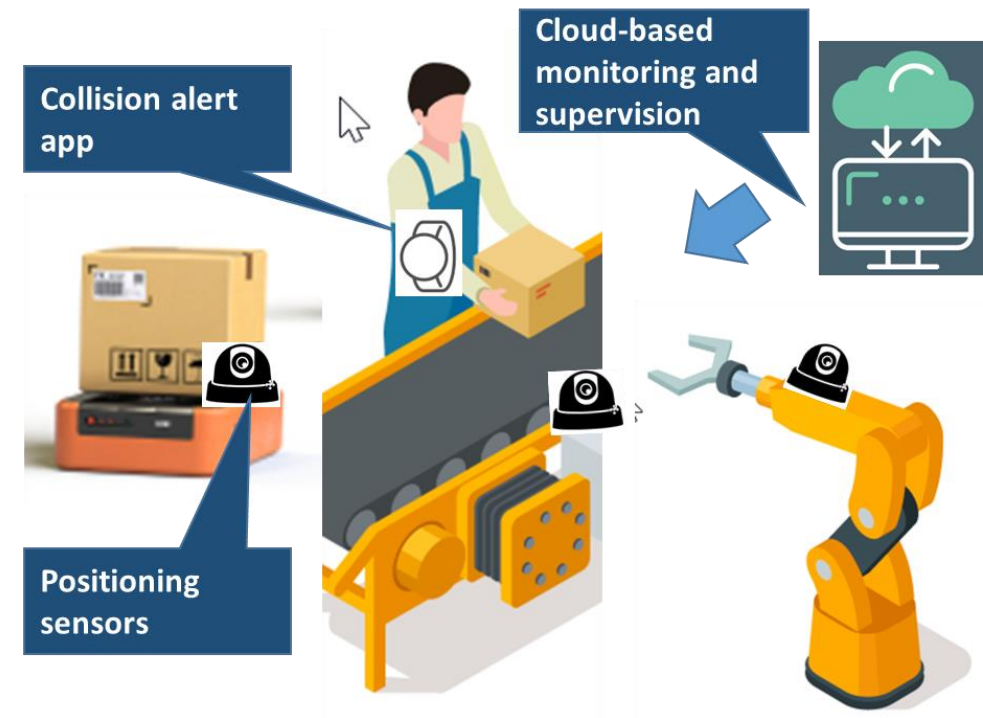
SA4CPS Situational awareness for critical cyber-physical systems



- Sensor systems design and implementation,
- Ultrasonic and Time of Flight technology for object movement detection,
- AI & ML tool chain application

IMA challenge

- ⌚ AI based sensor system for a monitoring of an interaction among humans and machines (based on neural networks)
- ⌚ An early alert service for collision avoidance
- ⌚ Data sets acquisition for objects (HM) featuring
- ⌚ Situation modeling
- ⌚ Digital twin approach for system testing and training

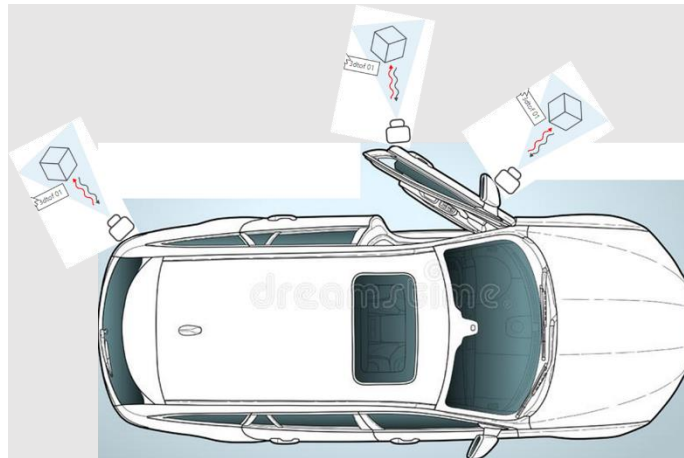


AI4CSM

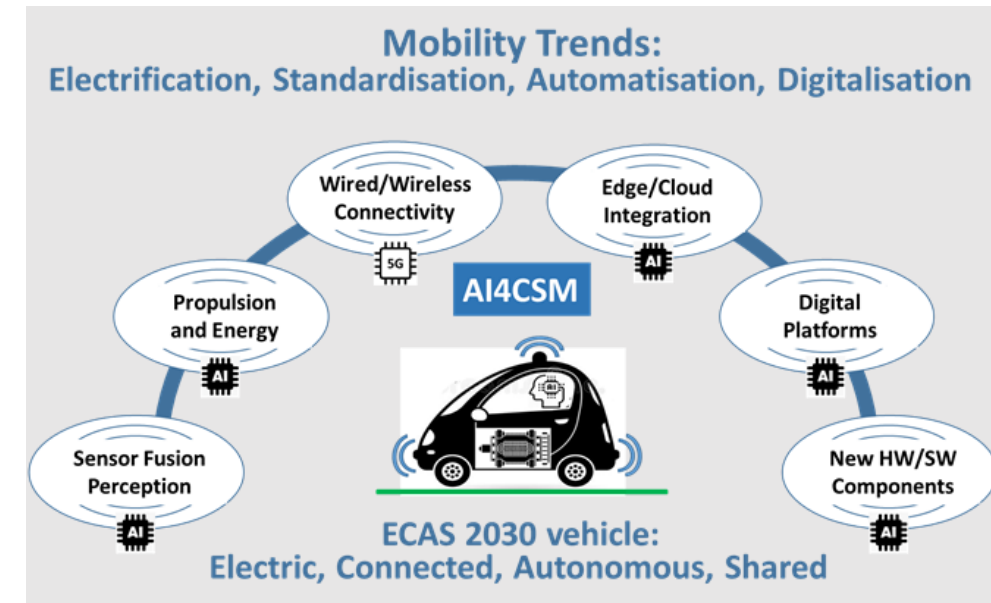
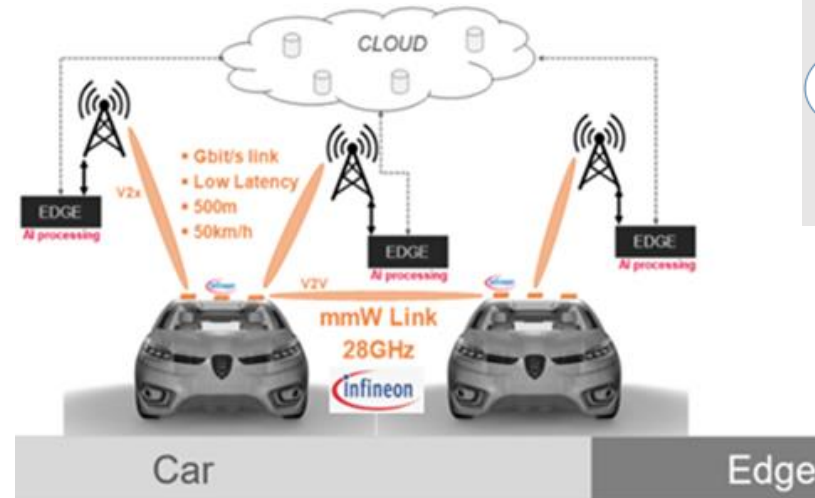
Automotive Intelligence for Connected Shared Mobility



Perception, Sensor Fusion



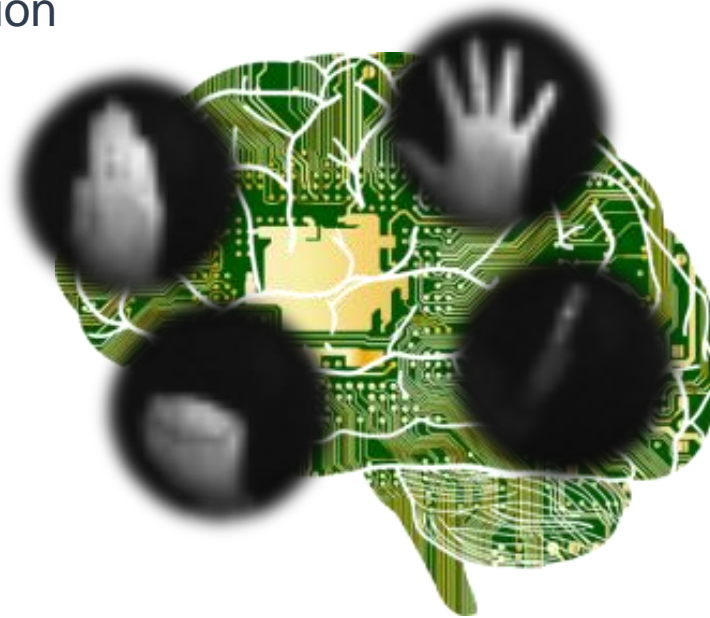
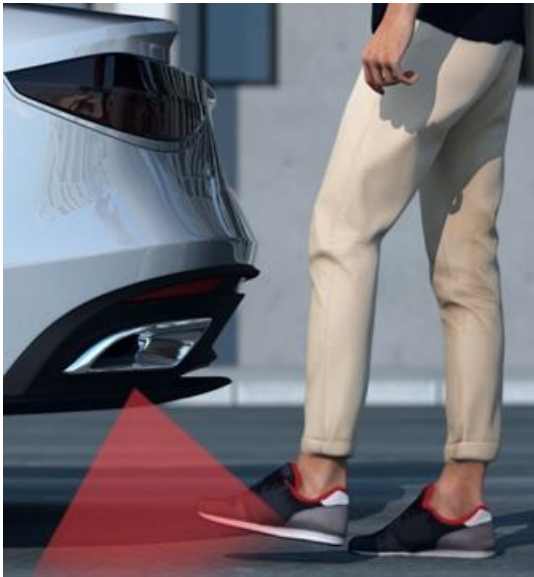
Connectivity & Communication



Embedded storage elements on next MCU generation ready for **A_{ge}** on the edge

IMA challenges

- ⌚ Low resolution Time of Flight sensor matrix gesture recognition
- ⌚ Embedded Neural network data processing
- ⌚ Algorithmic generalization



EECONE European ECOsystem for Green Electronic



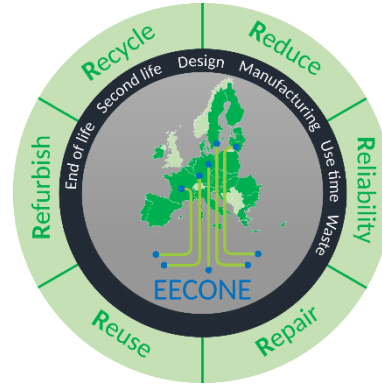
Environmental impact is far beyond energy!

IMA challenges

- ☾ Reusable modular architecture
- ☾ Functional integration for decreasing components count and energy consumption
- ☾ System lifetime prolongation
- ☾ OTA
- ☾ Life-time respecting mission profile investigation



Source: The Global E-waste Monitor 2020 (United Nations University)





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